



#### **60V N-CHANNEL ENHANCEMENT MODE MOSFET** POWERDI<sup>®</sup>

### **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub>	I <sub>D</sub> T <sub>C</sub> = +25°C
60V	$16m\Omega @ V_{GS} = 10V$	31A
607	$24m\Omega$ @ $V_{GS} = 4.5V$	24A

#### **Description**

This new generation N-Channel Enhancement Mode MOSFET is designed to minimize R<sub>DS(ON)</sub> and yet maintain superior switching performance. This device is ideal for use in Notebook battery power management and load switch.

### **Applications**

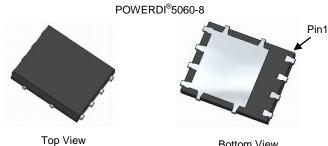
- Motor Control
- DC-DC Converters
- **Power Management**

#### **Features**

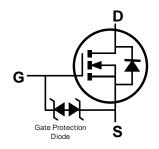
- Thermally Efficient Package-Cooler Running Applications
- High Conversion Efficiency
- Low R<sub>DS(ON)</sub> Minimizes On State Losses
- Low Input Capacitance
- Fast Switching Speed
- <1.1mm Package Profile Ideal for Thin Applications
- **ESD Protected Gate**
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

#### **Mechanical Data**

- Case: POWERDI®5060-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe; Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.097 grams (Approximate)



**Bottom View** 



Internal Schematic

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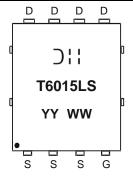
#### **Ordering Information** (Note 4)

Part Number	Case	Packaging
DMT6015LPS-13	POWERDI <sup>®</sup> 5060-8	2,500 / Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green"
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

### Marking Information



☐ I = Manufacturer's Marking T6015LS = Product Type Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 14 = 2014) WW = Week Code (01 to 53)

POWERDI is a registered trademark of Diodes Incorporated. DMT6015LPS



### **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	V <sub>DSS</sub>	60	V	
Gate-Source Voltage	V <sub>GSS</sub>	±16	V	
Continuous Durin Courset (Note C) V	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	ΙD	10.6 8.5	А
Continuous Drain Current (Note 6) V <sub>GS</sub> = 10V	$T_{C} = +25^{\circ}C$ $T_{C} = +70^{\circ}C$	I <sub>D</sub>	31 25	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I <sub>DM</sub>	60	Α	
Maximum Continuous Body Diode Forward Current (Note 6)	Is	2	Α	
Avalanche Current (Note 7) L=0.1mH	I <sub>AS</sub>	10	Α	
Avalanche Energy (Note 7) L=0.1mH	E <sub>AS</sub>	5	mJ	
V <sub>DS</sub> Spike t=10μs		V <sub>SPIKE</sub>	75	V

### **Thermal Characteristics**

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)		PD	1.16	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady state	-	108	°C/W
	t<10s	$R_{\theta JA}$	56	
Total Power Dissipation (Note 6)		PD	2.7	W
Thermal Decistors and Investigate Ambient (Nets C)	Steady state	-	46	°C/W
Thermal Resistance, Junction to Ambient (Note 6)	t<10s	$R_{\theta JA}$	24	
Thermal Resistance, Junction to Case (Note 6)		$R_{\theta JC}$	4.4	°C/W
Operating and Storage Temperature Range		T <sub>J,</sub> T <sub>STG</sub>	-55 to +150	°C

#### Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

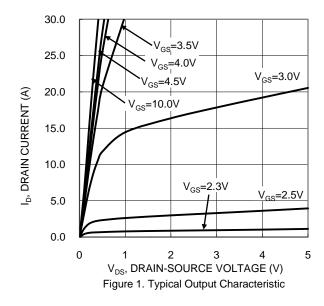
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	$BV_{DSS}$	60	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	_	1	μΑ	$V_{DS} = 48V, V_{GS} = 0V$	
Gate-Source Leakage	I <sub>GSS</sub>	_	_	±10	μΑ	$V_{GS} = \pm 16V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	0.5	-	2.5	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$	
Static Drain-Source On-Resistance		_	14.2	16	mΩ	$V_{GS} = 10V, I_D = 10A$	
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	_	18	24	11177	$V_{GS} = 4.5V, I_D = 6A$	
Diode Forward Voltage	$V_{SD}$	_	0.7	1.2	V	$V_{GS} = 0V, I_{S} = 1A$	
DYNAMIC CHARACTERISTICS (Note 9)				•			
Input Capacitance	C <sub>iss</sub>	_	1103	_		$V_{DS} = 30V$ , $V_{GS} = 0V$ , $f = 1MHz$	
Output Capacitance	Coss	_	251.3	_	pF		
Reverse Transfer Capacitance	C <sub>rss</sub>	_	19.7	_			
Gate Resistance	R <sub>G</sub>	_	1.5	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$	
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qg	_	8.9	_			
Total Gate Charge (V <sub>GS</sub> = 10V)	Qg	_	18.9	_	~_	V <sub>DS</sub> = 30V, I <sub>D</sub> = 10A	
Gate-Source Charge	Qgs	_	3.0	_	nC		
Gate-Drain Charge	$Q_{qd}$	_	2.8	_			
Turn-On Delay Time	t <sub>D(ON)</sub>	_	4.1	_		V <sub>GS</sub> = 10V, V <sub>DS</sub> = 30V,	
Turn-On Rise Time	t <sub>R</sub>	_	7.1	_			
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	19.5	_	ns	$R_G = 6\Omega$ , $I_D = 10A$	
Turn-Off Fall Time	t <sub>F</sub>	_	8.6	_			
Reverse Recovery Time	t <sub>RR</sub>	_	21.2	_	ns	1 400 11/11 4000/	
Reverse Recovery Charge	Q <sub>RR</sub>	_	13.2	_	nC	I <sub>F</sub> = 10A, di/dt = 100A/μs	

Notes:

5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
7. I<sub>AS</sub> and E<sub>AS</sub> ratings are based on low frequency and duty cycles to keep T<sub>J</sub> = +25°C.
8. Short duration pulse test used to minimize self-heating effect.
9. Guaranteed by design. Not subject to product testing.

2 of 6





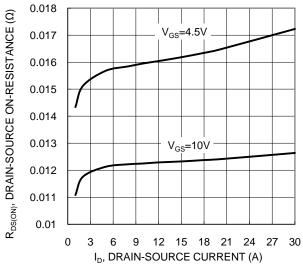


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

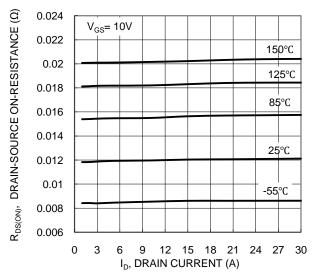
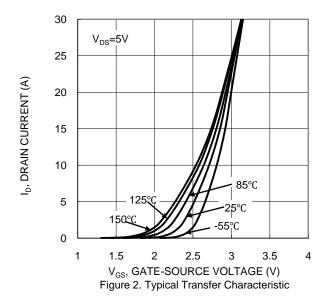
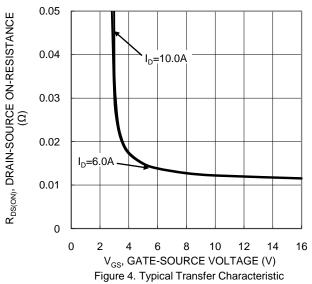


Figure 5. Typical On-Resistance vs. Drain Current and Temperature





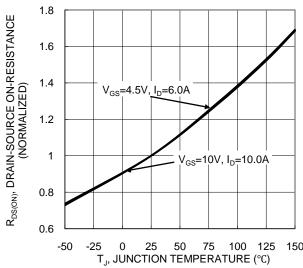


Figure 6. On-Resistance Variation with Temperature



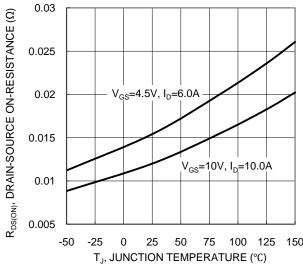
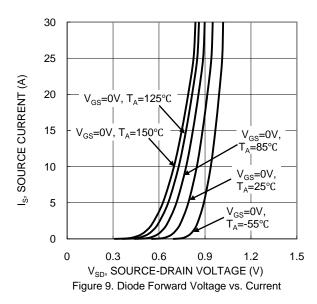
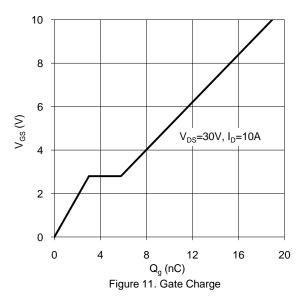


Figure 7. On-Resistance Variation with Temperature





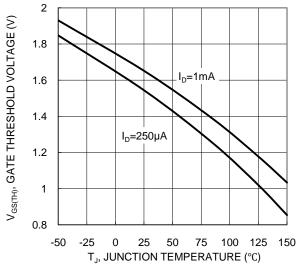
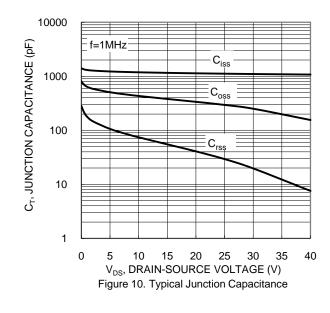
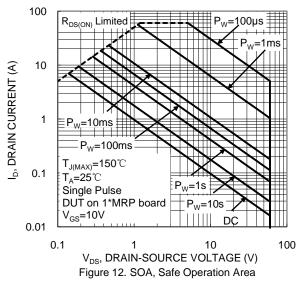
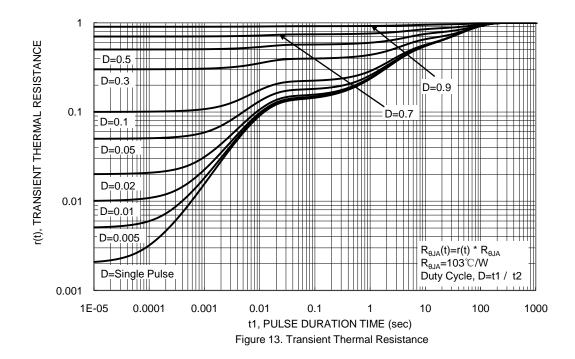


Figure 8. Gate Threshold Variation vs. Temperature



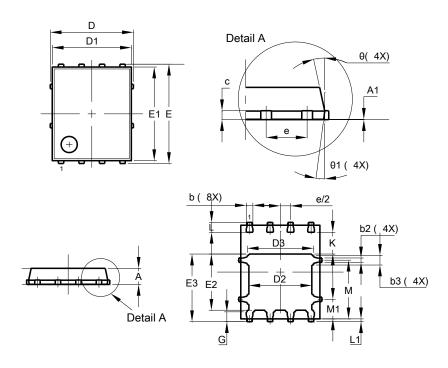






## **Package Outline Dimensions**

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

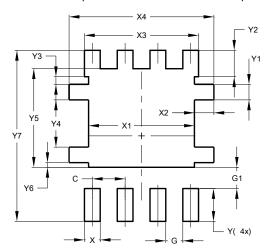


POWERDI®5060-8					
Dim	Min	Max	Тур		
Α	0.90	1.10	1.00		
A1	0.00	0.05	-		
b	0.33	0.51	0.41		
b2	0.200	0.350	0.273		
b3	0.40	0.80	0.60		
С	0.230	0.330	0.277		
D	5.15 BSC				
D1	4.70	5.10	4.90		
D2	3.70	4.10	3.90		
D3	3.90	4.30	4.10		
Е	6.15 BSC				
E1	5.60	6.00	5.80		
E2	3.28	3.68	3.48		
E3	3.99	4.39	4.19		
е	1.27 BSC				
G	0.51	0.71	0.61		
K	0.51	-	-		
L	0.51	0.71	0.61		
L1	0.100	0.200	0.175		
М	3.235	4.035	3.635		
M1	1.00	1.40	1.21		
θ	10°	12º	11º		
θ1	6º	8º	7º		
All Dimensions in mm					



#### Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)			
С	1.270			
G	0.660			
G1	0.820			
Х	0.610			
X1	4.100			
X2	0.755			
Х3	4.420			
X4	5.610			
Υ	1.270			
Y1	0.600			
Y2	1.020			
Y3	0.295			
Y4 1.825				
Y5	3.810			
Y6	0.180			
Y7	6.610			

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